

date 04/03/2017

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MODEL: HSS-C2540-SMT-TR | DESCRIPTION: HEAT SINK

FEATURES

- TO-263 package
- low profile design
- surface mount
- tape and reel pack





thermal resistance¹ power dissipation¹ @ 1 W, 400 LFM @ 75°C ∆T, @ 75°C ∆T, @ 1 W, @ 1 W, 200 LFM nat conv nat conv nat conv (°C/W) (°C/W) (°C/W) (°C/W) (W) HSS-C2540-SMT-TR 19.74 21.90 5.50 4.00 3.80

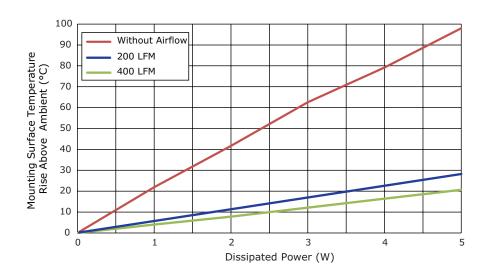
Note: 1. See performance curves for full thermal resistance details.

PERFORMANCE CURVES

	Heatsink Temperature Rise Above Ambient ($\Delta T = Ths - Ta$) (°C)		
Power (W)	Natural Conv.	200 LFM	400 LFM
0	0	0	0
1	21.90	5.50	4.00
2	41.68	11.15	7.79
3	62.55	16.69	12.14
4	79.22	22.44	16.40
5	98.00	28.21	20.66

Ths: "hot spot" temperature measured on the heatsink

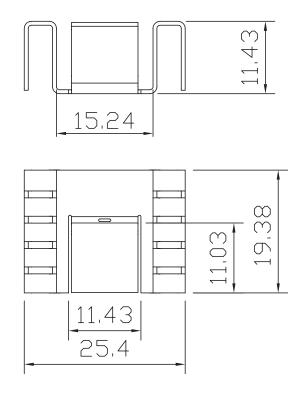
Ta: ambient temperature



MECHANICAL DRAWING

units: mm tolerance: ±0.3 mm

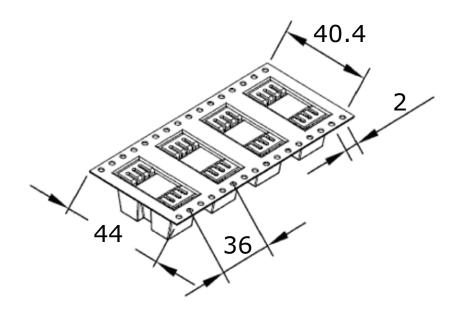
MATERIAL	C1100
FINISH	tin plated
THICKNESS	0.6 mm
WEIGHT	8.9 g



PACKAGING

units: mm

Reel QTY: 150 pcs per reel



REVISION HISTORY

rev.	description	date
1.0	initial release	04/03/2017

The revision history provided is for informational purposes only and is believed to be accurate.



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CUI offers a one (1) year limited warranty. Complete warranty information is listed on our website.

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